

1. Consider a common-source amplifier with resistor load (R_L) of 600Ω , $V_{DD} = 1.8V$, $V_{in,DC} = 0.9V$, $temp = 27^\circ$, $k = 1.38 \times 10^{-23} \text{ J/K}$

a. Consider only the thermal noise of R_L

i. Calculate the output noise power (in terms of V^2/Hz).

$$S_{v,R_L} = 4kTR_L = (3.15\text{nV})^2/\text{Hz} = 9.94 \times 10^{-18} \text{ V}^2/\text{Hz}$$

ii. Calculate the total rms output noise voltage over the frequency range from DC to 1 GHz.

$$9.94 \times 10^{-18} \text{ (V}^2/\text{Hz)} \times 10^9 \text{ (Hz)} = 9.94 \times 10^{-9} \text{ V}_{\text{rms}}^2$$

iii. With load capacitor (C_L) of 100 fF, calculate the total rms output noise voltage over the entire frequency range.

$$P_{n,\text{out}} = \frac{kT}{C} = 4.14 \times 10^{-8} \text{ V}_{\text{rms}}^2$$

b. Hspice

i. With dc analysis, report the following of your final design.

Gain = -2.27 , 3 – dB bandwidth = 2.6G Hz

$(W/L)_1 = 10\text{u}/0.2\text{u}$, Power consumption = 2.15mW

$V_{\text{out,DC}} = 1.0851\text{V}$

ii. With ac analysis from 1 kHz to 100 GHz, plot the frequency response from V_{in} , to V_{out} over 1 kHz to 100 GHz.



iii. With noise analysis from 1 kHz to 100 GHz, report the following.

| File | Equation | Specification | | Result | | Pass/Fail |
|------------|---|---------------|-----|--------|------|-----------|
| | | Min | Max | Value | Mean | |
| D0:1_a.ac0 | <code>integ(abs('0noise(outnoise)'), 1k, 100g)</code> | | | 98n | | |

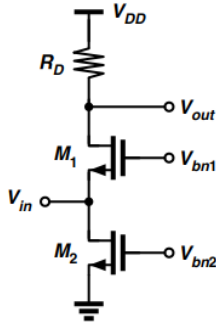
- The total rms output noise voltage over the frequency range from 1kHz to 1GHz is $98\text{n V}_{\text{rms}}^2$
- The reason why there are difference between hand calculations and the result of simulation is that we ignored the effect of flicker

noise, which plays an important role on the low frequency, and this will, and the noise come from transistor. Moreover, the frequency range in hand calculation is from DC to 1 GHz, and the frequency range in simulation is from 1kHz to 100GHz.

I also Integrate the above waveform (output noise PSD) over 1 kHz to 1 GHz, and the result is $23.1n V_{\text{rms}}^2$, which is closer to the result of hand calculation.

- The total rms output noise voltage contributed by the transistor is $98n - 9.94n = 88.1n V_{\text{rms}}^2$
- $\overline{V_{n,\text{out}}^2} = A_v^2 \overline{V_{n,\text{in}}^2} \Rightarrow \overline{V_{n,\text{in}}^2} = \sqrt{98n/(-2.27)^2} = 1.38 \times 10^4 V_{\text{rms}}^2$

2. Assume $\lambda = \gamma = 0$. Consider the following circuit (Ignore channel-length modulation & body effect)



- a. Calculate the dc voltage gain.

$$\lambda = 0 \rightarrow r_o = 0 \Rightarrow V_{\text{out}} = -V_{\text{in}} g_{m1} R_D \Rightarrow A_v = -g_{m1} R_D$$

- b. Calculate the output swing.

$$V_{\text{out}} \geq V_{\text{ov1}} + V_{\text{ov2}}, V_{\text{out}} \leq V_{\text{DD}}$$

$$\Rightarrow V_{\text{out,swing}} = V_{\text{DD}} - (V_{\text{bn1}} - V_{\text{in}} - V_{\text{TH1}}) - (V_{\text{bn2}} - V_{\text{TH2}})$$

- c. Calculate the input-referred thermal noise voltage (in terms of $V/\sqrt{\text{Hz}}$) and input-referred thermal noise current (in terms of $A/\sqrt{\text{Hz}}$).

- i. Input-referred thermal noise voltage

$$S_{v,V_{\text{out}}} = S_{v,R_D} + S_{v,M1} + S_{v,M2} = (4kT/R_D) \times R_D^2 + (4kT\gamma/g_{m2}^{-1}) \times R_D^2$$

$$S_{v,V_{\text{in}}} = \frac{S_{v,V_{\text{out}}}}{A_v^2} = 4kT \left(\frac{1}{g_{m1}^2 R_D} + \frac{g_{m2} \gamma}{g_{m1}^2} \right) \Rightarrow \overline{V_{n,\text{in}}} = \sqrt{4kT \left(\frac{1}{g_{m1}^2 R_D} + \frac{\gamma}{g_{m1}} \right)}$$

- ii. Input-referred thermal noise current

When calculate $\overline{I_{n,\text{in}}^2}$, we need to open the input.

$$S_{v,I_{\text{in}}} = S_{v,V_{\text{out}}}/R_{\text{out}}^2 = 4kT(R_D^{-1} + \gamma g_{m2}) \Rightarrow \overline{I_{n,\text{in}}} = \sqrt{4kT(R_D^{-1} + \gamma g_{m2})}$$

- d. Use $\mu_n C_{\text{ox}} = 303 \mu\text{A}/\text{V}^2$ and $\mu_p C_{\text{ox}} = 91 \mu\text{A}/\text{V}^2$ for the calculation. Set $V_{\text{DD}} = 1.8\text{V}$. $I_{D,M1} = I_{R_D} = 1 \text{ mA}$ and $(W/L)_1 = 6 \mu\text{m}/0.18 \mu\text{m}$. Design

R_D and $(W/L)_2$ so that the dc voltage gain is at least 3 V/V, output swing is at least 1.2 V, and the input referred thermal noise voltage and current are minimized. Describe how the circuit is designed.

- i. DC voltage gain is at least 3 V/V

$$A_v = -g_{m1}R_D, g_{m1} = \mu_n C_{ox}(W/L)_1 V_{ov1}$$

$$I_{D,M1} = 0.5\mu_n C_{ox}(W/L)_1 V_{ov1}^2 = 1\text{mA} \Rightarrow V_{ov1} = 0.445 \Rightarrow g_{m1} = 4.5\text{m}\Omega^{-1}$$

$$\Rightarrow |\text{Gain}| = g_{m1}R_D \geq 3 \Rightarrow R_D \geq 666.67\Omega$$

- ii. Output swing is at least 1.2 V

$$V_{\text{out,swing}} = V_{DD} - V_{ov1} - V_{ov2} = 1.8 - 0.445 - V_{ov2} \geq 1.2\text{V}$$

$$\Rightarrow V_{ov2} \leq 0.155\text{V}$$

$$I_{D,M2} = 0.5\mu_n C_{ox}(W/L)_2 V_{ov2}^2 = 1\text{mA}$$

- iii. Input referred thermal noise voltage and current are minimized

$$S_{n,V_{in},R_D} = 4kTR_D/(g_{m1}R_D)^2$$

$$\Rightarrow \text{My design is that } V_{ov2}(=V_{bn2} - V_{TH2}) = 0.122\text{V,}$$

$$(W/L)_2 = (70\mu/0.18\mu), \text{ and } R_D = 1500\Omega.$$

- e. Hspice

- i. Keep the device sizes unchanged. Adjust the bias voltages

($V_{in,DC}$, V_{bn1} , and V_{bn2}) so that no DC current flows through V_{in} , and the bias current is less than 1 mA while maintaining all transistors in saturation.

```
subckt
element 0:m1 0:m2
model 0:n_18.1 0:n_18.1
region Saturati Saturati
id 704.4097u 700.5893u
ibs -1.685e-19 -1.451e-19
ibd -374.6739a -1.3934f
vgs 900.0000m 577.0000m
vds 543.3855m 200.0000m
vbs 0. 0.
vth 503.7659m 512.7566m
vdsat 273.6230m 119.6630m
vod 396.2341m 64.2434m
beta 11.6160m 137.9506m
gam_eff 507.4528m 507.4465m
gm 2.4968m 9.4838m
gds 243.2238u 899.7118u
gmb 366.1920u 1.4339m
cdtot 8.3362f 103.6703f
cgtot 11.2185f 124.2395f
cstot 16.0386f 176.3318f
cbtot 14.8579f 178.5529f
cgs 8.1220f 86.5888f
cgd 2.1908f 25.8128f
```

```
**** small-signal transfer characteristics

v(vout)/vin = 3.0088
input resistance at vin = 344.2079
output resistance at v(vout) = 1.0994k
```

```
subckt
element 0:vin 0:vbn1 0:vbn2 0:vdd 0:vss
volts 200.0000m 1.1000 577.0000m 1.8000 0.
current 3.8204u 0. 0. -704.4097u 704.4097u
power -764.0811n 0. 0. 1.2679m 0.

total voltage source power dissipation= 1.2672m watts
```

- ii. With dc analysis, report the following.
 - $V_{in,DC} = 0.2V, V_{bn1} = 1.1V,$ and $V_{bn2} = 0.577V$
 - Power consumption = 1.2672mW
 - $V_{out,DC} = 743.38mV$

iii. With ac analysis from 1 kHz to 100 GHz, plot the frequency response from V_{in} , to V_{out} over 1 kHz to 100 GHz.



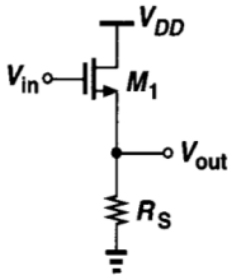
iv. With noise analysis from 1 kHz to 100 GHz, report the following.



- $\overline{V_{n,out}^2} = A_v^2 \overline{V_{n,in}^2}, \overline{V_{n,in}^2} = \sqrt{4kTR_D / (g_{m1}R_D)^2}$
- At $f = 1GHz$
 By simulation, $\overline{V_{n,out}^2} = 5.47 \times 10^{-17} \Rightarrow \overline{V_{n,in}^2} = 2.46nV/\sqrt{Hz}$
 By hand calculation, $\overline{V_{n,in}^2} = 1.73 nV/\sqrt{Hz}$ with $\gamma = 2/3$

- At $f = 10\text{GHz}$
By simulation, $\overline{V_{n,\text{out}}^2} = 4.12 \times 10^{-17} \Rightarrow \overline{V_{n,\text{in}}^2} = 2.13\text{nV}/\sqrt{\text{Hz}}$
By hand calculation, $\overline{V_{n,\text{in}}^2} = 1.73\text{nV}/\sqrt{\text{Hz}}$
- There is error between simulation and hand calculation since we ignore flicker noise. If I replace the value of g_{m1} with the real value, $g_{m1} = 2.5\text{m}\Omega^{-1}$, then we can get $\overline{V_{n,\text{in}}^2} = 2.48\text{nV}/\sqrt{\text{Hz}}$, which is similar to the result of simulation.
- $\overline{V_{n,\text{in},1\text{GHz}}^2}$ is larger than $\overline{V_{n,\text{in},10\text{GHz}}^2}$ since flicker noise plays an important role on the low frequency.

3. Calculate the input-referred thermal noise voltage (in terms of $V/\sqrt{\text{Hz}}$) of the following circuit. Assume $\lambda = \gamma = 0$.

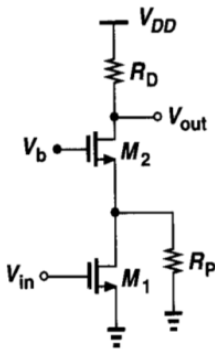


$$A_v = g_{m1} \times (g_{m1}^{-1} || R_S) = \frac{g_{m1} R_S}{1 + g_{m1} R_S} \approx 1$$

$$S_{v,\text{vout}} = 4kT \frac{(R_S || g_{m1}^{-1})^2}{R_S} + 4kT \gamma g_{m1} (R_S || g_{m1}^{-1})^2$$

$$\overline{V_{n,\text{in}}} = \sqrt{S_{v,\text{vout}}/A_v^2} \approx \frac{1 + g_{m1} R_S}{g_{m1} R_S} \sqrt{4kT \left(\frac{(R_S || g_{m1}^{-1})^2}{R_S} + \gamma g_{m1} (R_S || g_{m1}^{-1})^2 \right)}$$

4. Assume $\lambda = \gamma = 0$. Calculate the input-referred thermal noise voltage (in terms of $V/\sqrt{\text{Hz}}$) of the following circuit with and without R_P .



- a. Without R_P

$$A_v = -g_{m1} (g_{m2} r_{o2} r_{o1} || R_D) = -g_{m1} R_D \quad (\lambda = 0)$$

$$S_{v,\text{vout}} = 4kT R_D + 4kT \gamma g_{m1} R_D^2 \quad (\text{Due to } V_{M2,S} \text{ is a floating point})$$

$$\overline{V_{n,\text{in}}} = \sqrt{S_{v,\text{vout}}/A_v^2} \approx \sqrt{4kT ((g_{m1} R_D)^{-1} + \gamma g_{m1}^{-1})}$$

b. With R_p

$$A_v = -g_{m1}(g_{m2}r_{o2}(r_{o1}||R_p)||R_D) = -g_{m1}R_D \quad (\lambda = 0)$$

Use Superposition to get output noise ($S_{v,vout}$)

i. By R_D : $S_{v,vout1} = (4kT/R_D) \times R_D^2$

ii. By M_2 : $S_{v,vout2} = (4kT\gamma/g_{m2}) \left(\frac{g_{m2}^{-1}}{R_p+g_{m2}^{-1}}\right)^2 (R_D)^2$

iii. By M_1 : $S_{v,vout3} = (4kT\gamma/g_{m1}) \left(\frac{R_p}{R_p+g_{m2}^{-1}}\right)^2 (R_D)^2$

iv. By R_p : $S_{v,vout4} = (4kT/R_p) \left(\frac{R_p}{R_p+g_{m2}^{-1}}\right)^2 (R_D)^2$

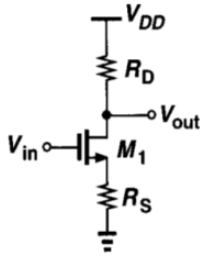
$$\Rightarrow S_{v,vout} = S_{v,vout1} + S_{v,vout2} + S_{v,vout3} + S_{v,vout4}$$

$$= 4kT(R_D + (\gamma g_{m2} R_D^2) \left(\frac{g_{m2}^{-1}}{R_p+g_{m2}^{-1}}\right)^2 + (\gamma g_{m1} R_D^2) \left(\frac{R_p}{R_p+g_{m2}^{-1}}\right)^2 + \left(\frac{R_D^2}{R_p}\right) \left(\frac{g_{m2}^{-1}}{R_p+g_{m2}^{-1}}\right)^2)$$

$$\Rightarrow \overline{V_{n,in}} = \sqrt{\frac{S_{v,vout}}{A_v^2}}$$

$$= \frac{1}{g_{m1}R_D} \sqrt{4kT(R_D + (\gamma g_{m2} R_D^2) \left(\frac{g_{m2}^{-1}}{R_p+g_{m2}^{-1}}\right)^2 + (\gamma g_{m1} R_D^2) \left(\frac{R_p}{R_p+g_{m2}^{-1}}\right)^2 + \left(\frac{R_D^2}{R_p}\right) \left(\frac{g_{m2}^{-1}}{R_p+g_{m2}^{-1}}\right)^2)}$$

5. Assume $\lambda = \gamma = 0$.



a. Calculate the input-referred thermal noise voltage (in terms of $V/\sqrt{\text{Hz}}$).

$$A_v = -\frac{g_{m1}R_D}{1+g_{m1}R_S}$$

$$S_{v,vout} = (4kT/R_D + 4kT\gamma g_{m1} \left(\frac{g_{m1}^{-1}}{g_{m1}^{-1}+R_S}\right)^2 + \frac{4kT}{R_S} \left(\frac{R_S}{g_{m1}^{-1}+R_S}\right)^2) (R_D)^2$$

$$\overline{V_{n,in}} = \sqrt{S_{v,vout}/A_v^2} = \frac{1+g_{m1}R_S}{g_{m1}R_D} \sqrt{4kT(R_D + \gamma g_{m1} \left(\frac{g_{m1}^{-1}}{g_{m1}^{-1}+R_S}\right)^2 + \frac{R_D^2}{R_S} \left(\frac{R_S}{g_{m1}^{-1}+R_S}\right)^2)}$$

b. If the thermal noise contributed by R_S is the same as that contributed from M_1 , how is the dc voltage drop across R_S compared to the overdrive voltage of M_1 ?

$$4kT\gamma g_{m1} \left(\frac{g_{m1}^{-1}}{g_{m1}^{-1}+R_S}\right)^2 (R_D)^2 = \frac{4kT}{R_S} \left(\frac{R_S}{g_{m1}^{-1}+R_S}\right)^2 (R_D)^2, g_{m1} = \frac{2I_D}{V_{ov1}}$$

$$g_{m1} = \frac{2I_D}{V_{ov1}} = \frac{\gamma}{R_S} \Rightarrow I_D R_S = \frac{\gamma}{2} V_{ov1}$$